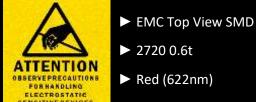




# **PRODUCT DATASHEET**



- ▶ 2720 0.6t
- Red (622nm)



## 2720 0.6t Series



## **FEATURES:**

- Package: EMC Mono Colour Top View SMD
- Forward Current: 350~700mA
- Forward Voltage (typ.): 2.2V
- Luminous Flux (typ.): 48lm@350mA; 90lm@700mA •
- Colour: Red .
- Wavelength (typ.): 622nm .
- Viewing angle: 120° •
- **Materials:** 
  - Resin: Silicone (Water Clear) \_
  - Finishing: Ag plated \_
- Operating Temperature: -40~+125°C .
- Storage Temperature: -40~+125°C
- ESD (HBM): 2KV •
- Grouping parameters:
  - Forward voltage
  - Luminous flux \_
  - \_ Dominant wavelength
- Soldering methods: Reflow
- MSL: acc. to JEDEC Level 2a
- Packing: 8mm tape with max.2000/reel, ø180mm (7") •

# NOR57S98

2720 0.6t Series

**APPLICATIONS:** 

Automotive Lighting

**Decoration Lighting** 



## **CHARACTERISTICS:**

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lf	700	mA
Peak Forward Current Duty 1/10; width 0.1ms	IFP	1500	mA
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @5V	IR	10	μΑ
Junction Temperature	Tj	150	°C
Thermal Resistance Junction to Solder Point	Rth	19	°C/W
Operating Temperature	T <sub>OPR</sub>	-40~+125	°C
Storage Temperature	Tstg	-40~+125	°C

## Electrical & Optical Characteristics (Ta=25°C)

Daramatar	Sumbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	$V_{\text{F}}$	1.8	2.2	2.8	V	I <sub>F</sub> =350mA
Luminous Flux	Φv	38	48		lm	I⊧=350mA
Dominant Wavelength	$\lambda_{\text{D}}$	618	622	633	nm	I⊧=350mA
Peak Wavelength	$\lambda_{P}$		633		nm	I⊧=350mA
Spectral Line Half Bandwidth	Δλ		17		nm	I⊧=350mA
Viewing Angle	2 <b>0</b> 1/2		120		deg	I⊧=350mA

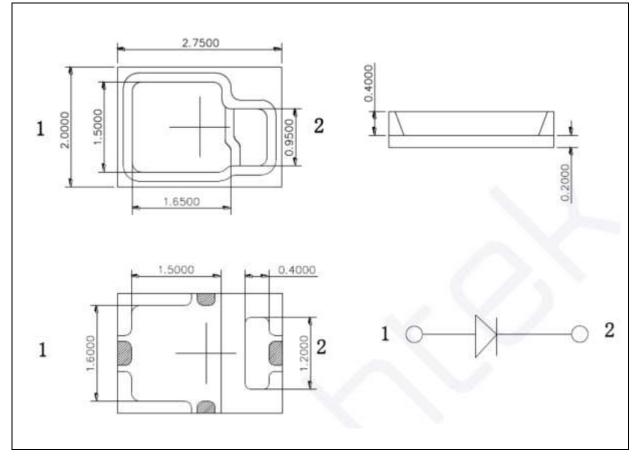
1. Luminous intensity (Iv)  $\pm 10\%$ , Forward Voltage (V<sub>F</sub>)  $\pm 0.1V$ .

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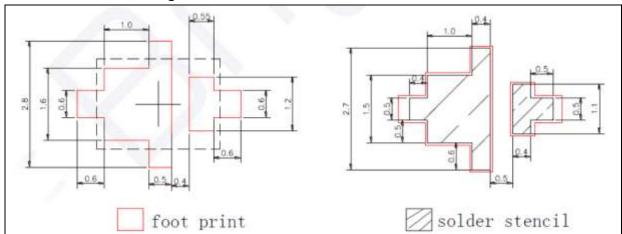


## **OUTLINE DIMENSION:**

#### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.



#### **Recommended Soldering Pad Dimension:**

- 1. Dimensions are in millimetre (mm).
- 2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



## **BINNING GROUPS:**

Code	Min.	Max.	Unit
E	1.8	2.0	
F	2.0	2.2	
G	2.2	2.4	V
Н	2.4	2.6	
J	2.6	2.8	

## Forward Voltage Classifications (I<sub>F</sub> = 350mA):

## Luminous Flux Classifications (I<sub>F</sub> = 350mA):

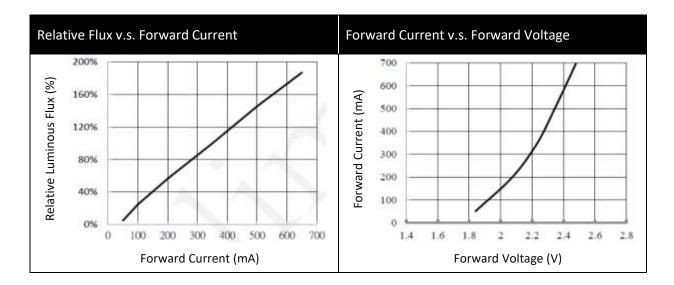
Code	Min.	Max.	Unit
19	38	44	
20	44	50	Im
21	50	58	lm
22	58	66	

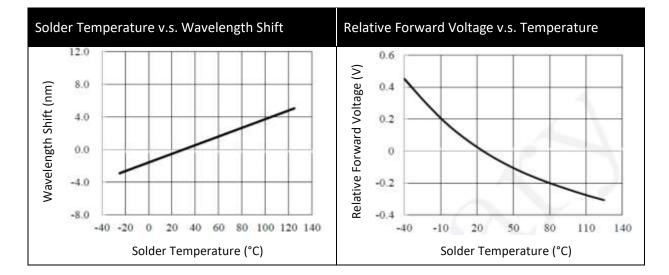
### Dominant Wavelength Classifications (I<sub>F</sub> = 350mA):

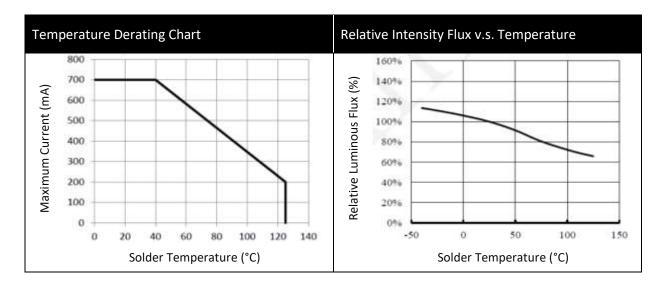
Code	Min.	Max.	Unit
V1	618	623	
V2	623	628	nm
V3	628	633	



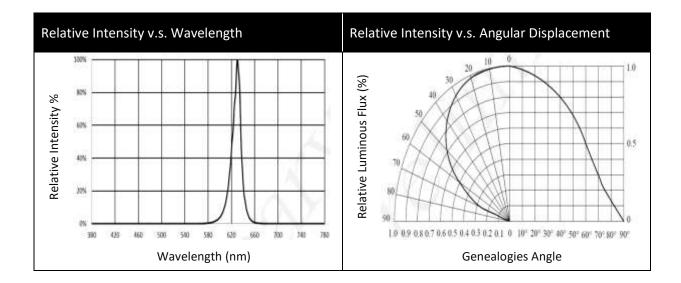
## **ELECTRO-OPTICAL CHARACTERISTICS:**

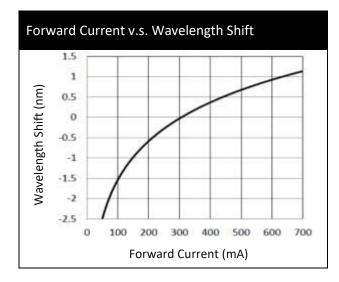










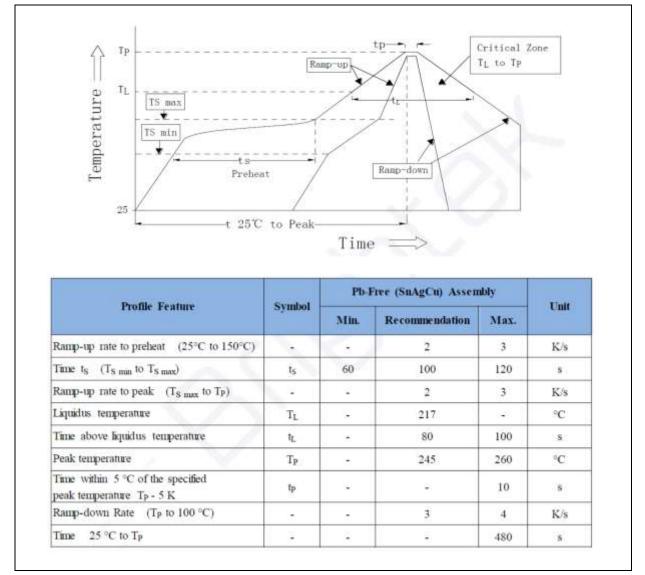


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## **RECOMMENDED SOLDERING PROFILE:**

#### Reflow solder:



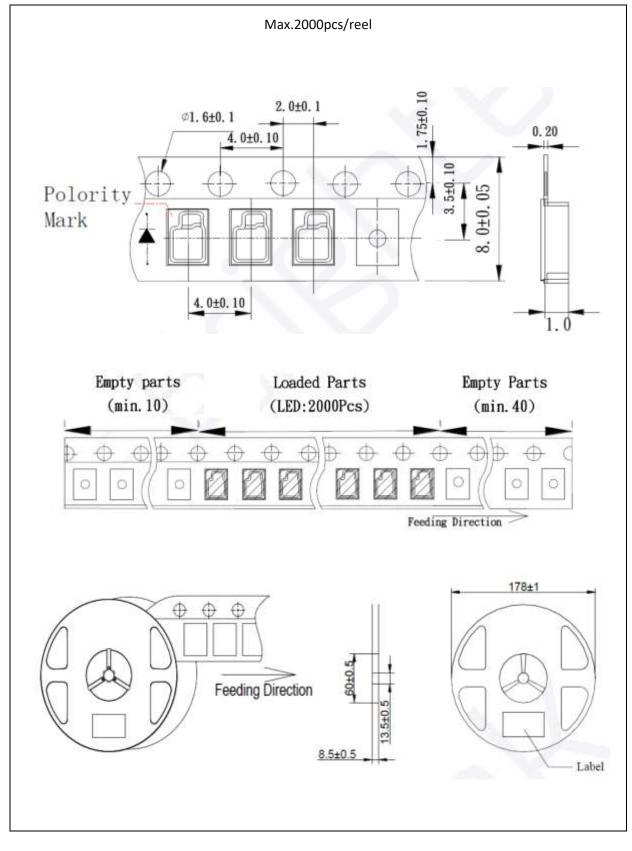
Note:

- 1. Recommend reflow temperature 245°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maxima reflow soldering: 3 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



## **PACKING SPECIFICATION:**

#### Reel Dimension:



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## **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within 4 weeks. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

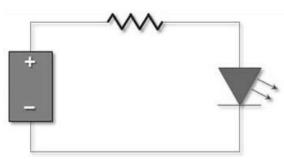
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



## Test Items and Reliability:

Test Item	Test Condition	Duration / Cycle	Failure Rate	Reference
Thermal Shock	-40°C 30mins ↓↑ 5mins 105°C 30mins	1000 cycles	0/26	JESD22 A-106
High Temperature Storage	Ta=105°C	1000hrs	0/26	JESD22 A-103B
Low Temperature Storage	Ta=-40°C	1000hrs	0/26	JESD22 A-119
Life Test	Ta=25°C I⊧=350mA	1000hrs	0/26	JESD22 A-108
High Humidity Heat Operation	Ta=85°C RH=85% I <sub>F</sub> =350mA	1000hrs	0/26	JESD22 A-101
High Temperature Operation	Ta=105°C I⊧=350mA	1000hrs	0/26	JESD22 A-108C
ESD (HBM)	2KV at 1.5KΩ 100pf	3 times	0/30	ANSI / JEDEC JS-001

Failure Criteria				
Item	Gunghal	Condition	Criteria for Judgment	
	Symbol	Condition	Min	Max
Forward Voltage	VF	I⊧=350mA	-	USL <sup>1</sup> x 1.1
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	-	10μΑ
Luminous Intensity	lv	I⊧=350mA	LSL <sup>2</sup> x 0.7	-

- 1. USL: Upper Specification Level.
- 2. LSL: Lower Specification Level.



## **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	27/11/2020	Datasheet set-up.
A1.1	23/04/2022	New datasheet format.